

Power Consumption in gates

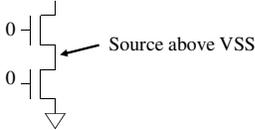


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Body effect and gates



- Difference between source and substrate voltages causes body effect.
- Source for gates in middle of network may not equal substrate:

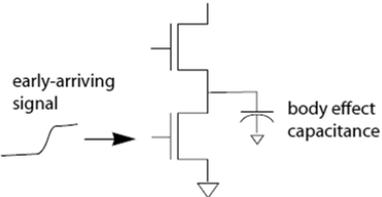


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Body effect and gate input ordering



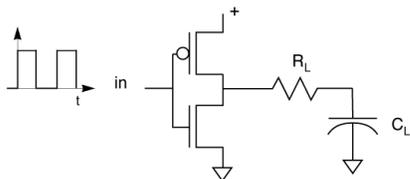
- To minimize body effect, put early arriving signals at transistors closest to power supply:



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Power consumption circuit

- Input is square wave.



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Power consuming Sources

Power is consumed by gates in two different ways:

- **dynamic power** is consumed when gates drive their outputs to new values;
- **static power** is consumed even when the gate is quiet and its output is not changing.

We can summarize this observation in a formula:

$$P = P_D + P_S$$

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Power consumption analysis

- Almost all power consumption comes from switching behavior.
- Static power dissipation comes from leakage currents.
- Surprising result: power consumption is independent of the sizes of the pullups and pulldowns.

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Power consumption

$$i_{CL}(t) = \frac{V_{DD} - V_{SS}}{R_p} e^{-(t/R_p C_L)}$$

$$v_{CL}(t) = (V_{DD} - V_{SS}) [1 - e^{-(t/R_p C_L)}]$$

$$E_c = \int_0^{\infty} i_{CL}(t) v_{CL}(t) dt$$

$$= C_L (V_{DD} - V_{SS})^2 \left(e^{-(t/R_p C_L)} \frac{1}{2} e^{-2t/R_p C_L} \right) \Big|_0^{\infty}$$

$$= \frac{1}{2} C_L (V_{DD} - V_{SS})^2$$

- A single cycle requires one charge and one discharge of capacitor: $E = C_L (V_{DD} - V_{SS})^2$.
- Clock frequency $f = 1/t$.
- Energy $E = C_L (V_{DD} - V_{SS})^2$.
- Power = $E \times f = f C_L (V_{DD} - V_{SS})^2$.

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Observations on power consumption

- Resistance of pullup/pulldown drops out of energy calculation.
- Power consumption depends on operating frequency.
 - Slower-running circuits use less power (but not less energy to perform the same computation).

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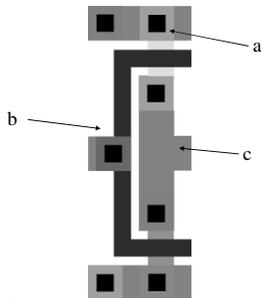
Speed-power product

- Also known as power-delay product.
- Helps measure quality of a logic family.
- For static CMOS:
 - $SP = P/f = CV^2$.
- Static CMOS speed-power product is independent of operating frequency.
 - Voltage scaling depends on this fact.

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Parasitics and performance

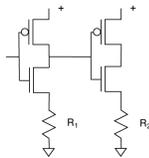


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Effect of parasitics

- a: Capacitance on power supply is not bad, can be good in absence of inductance. Resistance slows down static gates, may cause pseudo-nMOS circuits to fail.

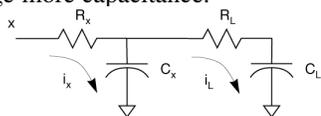


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Effects of parasitics, cont'd

- b: Increasing capacitance/resistance reduces input slope.
- c: Similar to parasitics at b, but resistance near source is more damaging, since it must charge more capacitance.



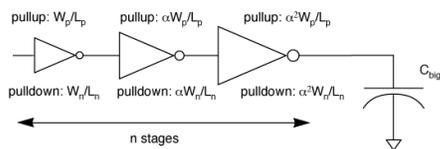
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Driving large loads

- Sometimes, large loads must be driven:
 - off-chip;
 - long wires on-chip.
- Sizing up the driver transistors only pushes back the problem—driver now presents larger capacitance to earlier stage.

Cascaded driver circuit



Optimal sizing

- Use a chain of inverters, each stage has transistors a larger than previous stage.
- Minimize total delay through driver chain:
 - $t_{tot} = n(C_{big}/C_g)^{1/n} t_{min}$.
- Optimal number of stages:
 - $n_{opt} = \ln(C_{big}/C_g)$.
- Driver sizes are exponentially tapered with size ratio α .
